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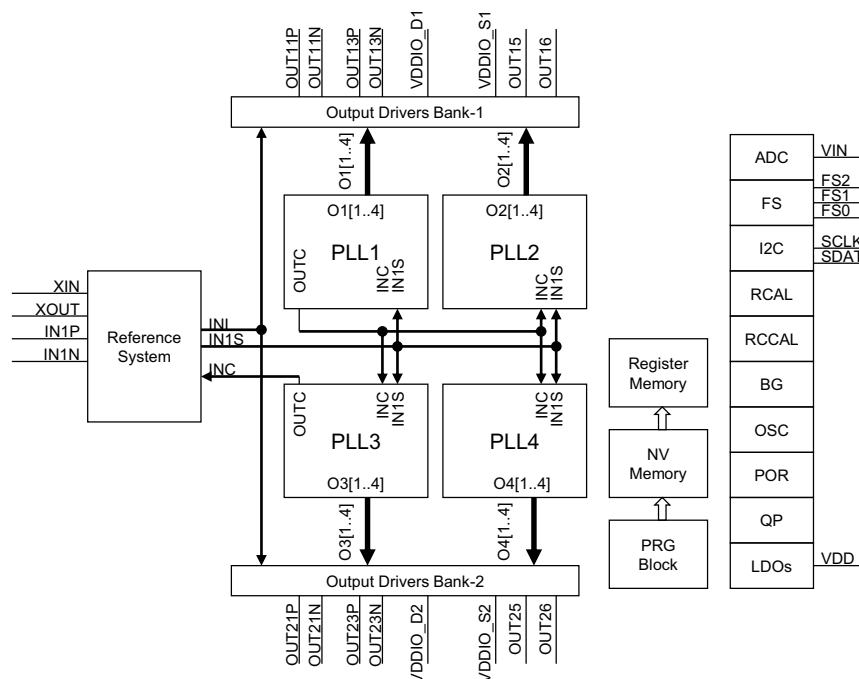
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# Four-PLL Spread-Spectrum Clock Generator

## Features

- Input frequencies
  - Crystal input: 8 MHz to 48 MHz
  - Reference clock: 8 MHz to 250 MHz LVCMOS
  - Reference clock: 8 MHz to 700 MHz differential
- Output frequencies
  - 25 MHz to 700 MHz LVDS, LVPECL, HCSL, CML
  - 3 MHz to 250 MHz LVCMOS
  - 1 kHz to 8 MHz for one LVCMOS output
- RMS phase jitter: 2-ps max at 12-kHz to 20-MHz offset
- PCIe 1.0/2.0 compliant
- SATA 2.0, USB 2.0/3.0, GbE compliant
- Maximum 8 outputs split in two banks with four outputs each.
  - Up to four differential output pairs (HCSL, LVPECL, CML, or LVDS)
  - Up to 8 LVCMOS outputs
- Up to 100-ps skew for differential outputs within a bank
- Four fractional N-type phase-locked loops (PLLs) with
  - VCXO ( $\pm 120$  ppm with steps of 0.23 ppm)
  - Spread-spectrum capability (Logic SS and Lexmark profile 0.1% to 5% in 0.1% steps, down or center spread)
- Supply voltage: 1.8 V, 2.5 V, and 3.3 V
- Non-zero delay buffer (NZDB) configurations
- I<sup>2</sup>C configurable with onboard programming
- Automotive-grade device, offered in 48-pin QFN (7 × 7 × 1.0 mm) package
- AEC-Q100 Qualified

## Logic Block Diagram



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## Functional Description

The CY27430 is a standard-performance programmable clock generator with four independent fractional PLLs, which generates any frequency with a zero-ppm synthesis error. Each PLL is followed by a set of four independent dividers to generate four different frequencies from a single PLL. All four dividers are synchronized to generate phase-aligned clock outputs with minimal skew. The PLLs also support the spread-spectrum feature to reduce EMI.

The CY27430 accepts a crystal clock or a single-ended/differential reference clock. The device supports up to 8 outputs, divided into two banks with four outputs each. Four outputs of PLL1 and PLL2 are multiplexed to output Bank1, and four clock outputs of PLL3 and PLL4 are multiplexed to output Bank2. The 8 outputs of the two banks are configurable as 4 differential outputs, 8 single-ended outputs, or a combination of differential and single-ended outputs.

The CY27430 has an on-chip volatile and nonvolatile memory, composed of eight registers, which store the device configuration settings. These registers can be accessed and programmed onboard through the I<sup>2</sup>C interface. You can also configure the device on-the-fly to completely reprogram the device on the application board. Besides the I<sup>2</sup>C interface, external signals can be applied to multifunction pins for different functions such as the following:

- Dynamically change the output frequency
- Output enable/disable
- Power down
- Spread ON/OFF

One low-frequency clock output, in kilohertz, is provided to meet the need of widely used reference frequencies, such as 32.768 kHz. The jitter specs of the CY27430 make it an ideal choice for the following communication protocols: PCIe 1.0/2.0, USB 2.0/3.0, SATA 1.0/2.0, and GbE.

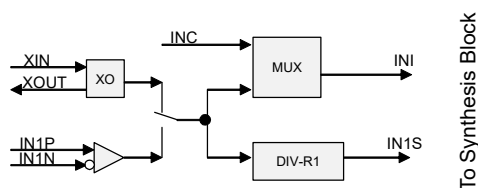
## Functional Overview

### Input System

The input system supports the following (see Figure 1):

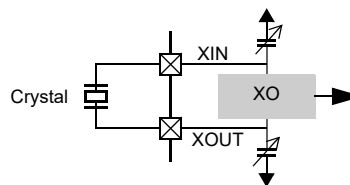
- XIN/XOUT supports crystal input.
- IN1 supports differential and single-ended clock inputs.

**Figure 1. Oscillator/Clock Input Block Diagram**



If a crystal is used, XIN and XOUT are connected to a crystal oscillator to generate the required internal frequency, as shown in Figure 2. The supported differential tuning capacitor range is 8 pF to 12 pF.

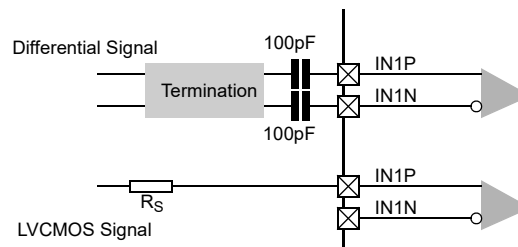
**Figure 2. Connecting a Crystal**



IN1 is designed to accept either a single-ended or differential reference input.

The differential inputs are capable of interfacing with multiple standards, such as LVPECL, LVDS, CML, and HCSL. The differential signals must be of AC-coupling, as shown in Figure 3.

**Figure 3. Interfacing Differential and Single-Ended Signals**



### VCXO Input Block

The VIN input is used for the VCXO functionality of the device. In this functionality, the output can change with respect to an input voltage required for audio-visual applications. The output frequency can vary up to  $\pm 120$  ppm. This input voltage directly controls the PLL1 fractional divider to provide the VCXO functionality.

### Frequency Select Input

The CY27430 supports frequency-select features with which the customer can change output frequencies on-the-fly. The device has eight configuration register sets, which can be preprogrammed or written through I<sup>2</sup>C. Changing the signal level of the FS pins (high and low) selects the appropriate configuration registers and changes the output frequency accordingly.

## I<sup>2</sup>C Block (SCLK, SDAT)

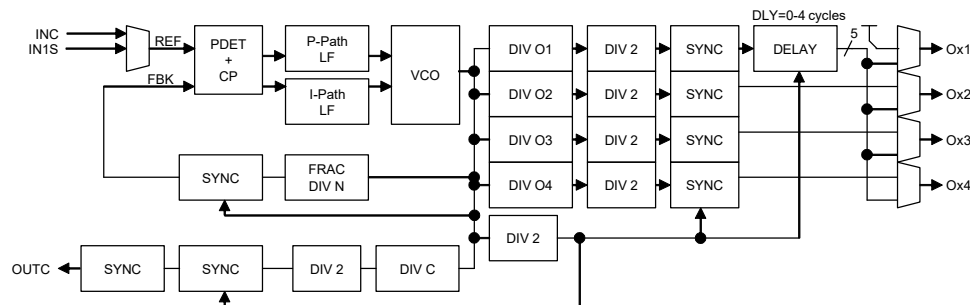
The CY27430 supports I<sup>2</sup>C programming of internal registers, which can be used to configure the device. The CY27430 also supports user-profile programming to flash memory and allows partial updates. Read, Write, or Read/Write protection is also available. The device is compliant with the I<sup>2</sup>C-bus Specification, version 2.1 or later. The critical I<sup>2</sup>C specifications are as follows:

- 400 kb/s (Fast mode)
- 7-bit addressing support
- Selectable device address (programmable), default = 69 hex (7 bits)

## Synthesis Section

The CY27430 contains four PLLs, which are the core synthesis blocks of the chip. Each PLL has a fractional N capability, which supports output frequency generation based on an input reference frequency to an accuracy of 100 ppb. The output of the PLL is fed into four dividers and then moves to synchronizers to generate glitch-free clock transition features, variable delay generation circuits to support the programmable delay feature, and so on. The output dividers and multiplexers are also included as part of this subsystem. All the four PLLs have the same architecture, as shown in [Figure 4](#).

### Figure 4. PLL Architecture

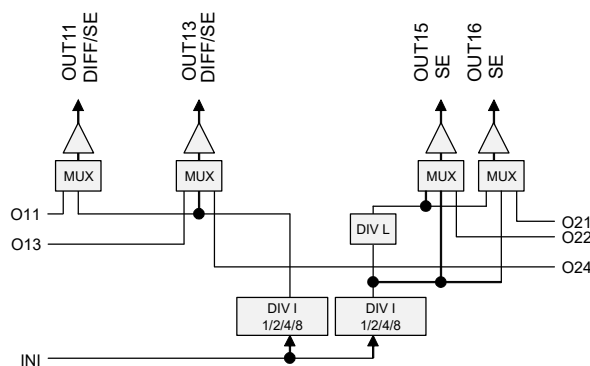


## Output Section

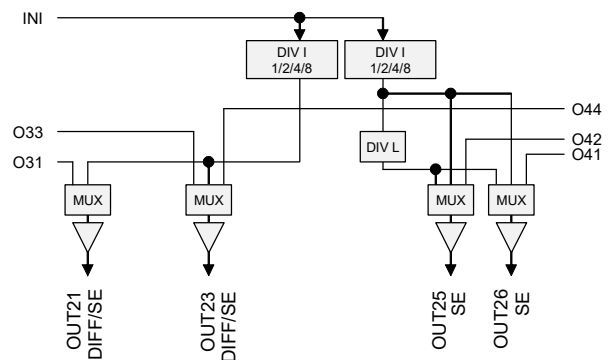
The CY27430 has two banks of outputs, which are located at the top and bottom of the device. Bank 1 consists of four outputs with OUT11 and OUT13 supporting both differential and single-ended outputs and OUT15 and OUT16 supporting only single-ended outputs. Bank 2 consists of four outputs with OUT21 and OUT23 supporting both differential and single-ended outputs and OUT25 and OUT26 supporting only single-ended output.

Each output is fed from a PLL through a divider and then to a MUX, which helps in selecting the source for the output, as shown in [Figure 5](#) and [Figure 6](#).

### Figure 5. Bank 1 Outputs



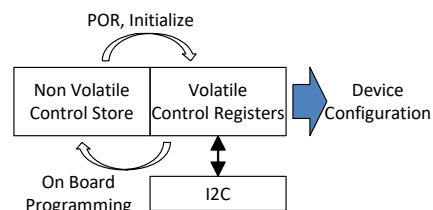
### Figure 6. Bank 2 Outputs



## Onboard Programming

One can write the device memory on the customer board, enabling the use of a blank device that is not preprogrammed. This enables use of the same device across multiple projects and lets you program the device based on individual projects. Conceptual onboard programming is shown in [Figure 7](#).

### Figure 7. Onboard Programming



## Functional Features and Application Considerations

The CY27430 is a four-PLL spread-spectrum clock generator targeted at consumer, industrial, and low-end networking applications. The key specifications of the part are differential input and outputs (8), supporting frequencies up to 700 MHz. The device has a low RMS phase jitter of 2-ps max and value-added features, such as VCXO, Frequency Select, and PLL Bypass modes. This part is designed to support key standards, such as PCIe 1.0/2.0, USB 2.0/3.0, and GbE.

The product supports LVDS, LVPECL, CML, HCSL, and LVCMOS logic levels.

### Clock Generator

The main feature of the CY27430 is frequency generation from an external reference (IN1) or a crystal. There are four variables to determine the final output frequency. They are input REF, the DIV-R (R1), FracN (DIV-N) dividers, and the post dividers (DIV-O). The basic formula for determining the final output frequency is:

#### ■ Clock Generator mode

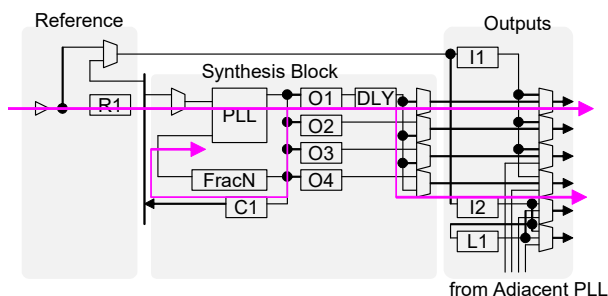
$$f_{OUT} = ((REF \times DIV-N) / DIV-R) / DIV-O$$

#### ■ PLL Bypass mode

$$f_{OUT} = REF / DIV-I \text{ or } REF / DIV-I / DIV-L$$

The basic PLL block diagram is shown in Figure 8. Each of the outputs from the PLL is fed to the output MUX through a Delay circuit that provides a certain delay to the individual clock, if needed.

**Figure 8. PLL Block Diagram, Clock Generation**



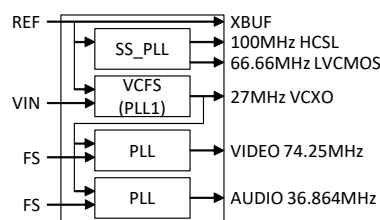
### PCIe (HCSL) Clock Generation

For PCIe applications, the CY27430 provides four differential outputs that have the same spread on it at any particular point of time.

### VCXO and Related Frequencies

CY27430 provides VCXO functionality and a cascading PLL option to generate critical frequencies with a fixed reference. Digital televisions have a requirement for the audio and video clocks to follow a 27-MHz VCXO signal so that they are synchronized. The architecture of the chip must ensure that this is met by cascading, as shown in Figure 9.

**Figure 9. Cascading PLLs**



Apart from having the audio and video clocks following the 27-MHz VCXO input, they also need complex divider ratios to generate the output frequencies. Commonly used divider ratios for audio and video signals are listed in Table 1.

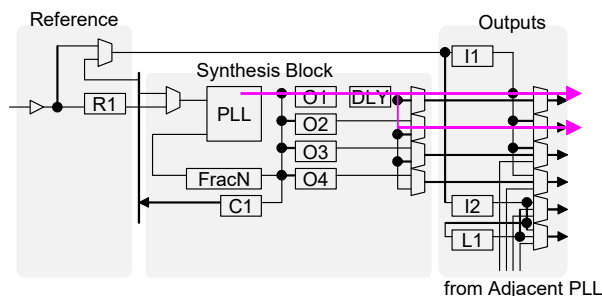
**Table 1. Audio and Video Frequencies**

| Output Frequency | Ratios    |
|------------------|-----------|
| 74.17582418      | 91:250    |
| 33.8688          | 625:784   |
| 22.5792          | 1875:1568 |
| 16.9344          | 1250:784  |
| 11.2896          | 1875:784  |
| 5.6448           | 1875:392  |
| 36.864           | 375:512   |

### Early/Late Output Phase

The CY27430 supports a delay circuit in the divider to provide 0 to  $4 \times VCO/2$  cycles. Therefore, an output has a certain lag phase or lead phase to other outputs when this feature is used. Refer to Figure 10.

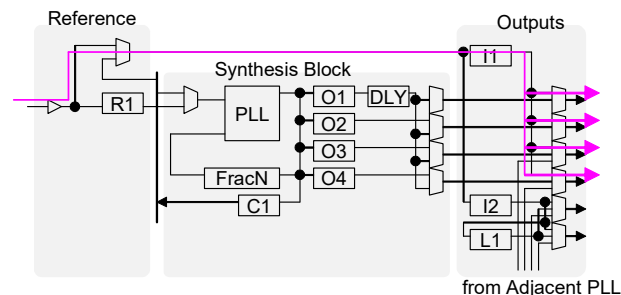
**Figure 10. Early/Delayed Phase Output**



### Non-Zero Delay Buffer

The CY27430 supports the PLL-bypass mode, which bypasses the entire synthesis block to act as a configurable non-zero delay buffer (NZDB) with level translation and selectable inputs, as shown in Figure 11.

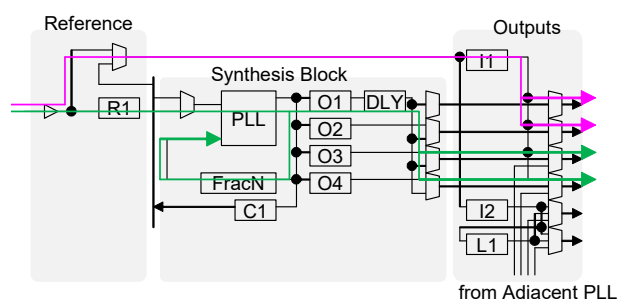
**Figure 11. NZDB Configuration**



#### Combination Clock Generator and Buffer

The CY27430 provides a combination of a clock generator and a buffer in one device. This is achieved by configuring the input and output selectors for the desired split configuration. An example of such an application is shown in Figure 12.

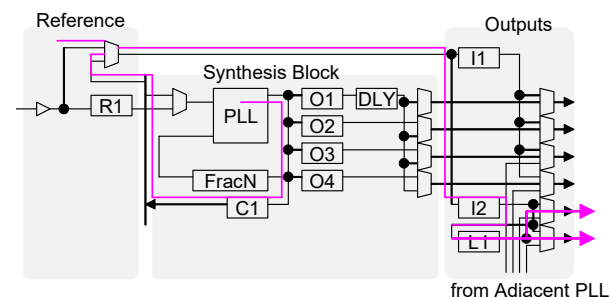
**Figure 12. Clock Generator and NZDB**



#### Low-Frequency Output

The CY27430 integrates low-frequency generator counters for LVCMOS outputs that may be used for watchdog-time and/or kHz-order clocks for application, as shown in Figure 13.

**Figure 13. Low-frequency Output Option**



#### Spread Spectrum

To help reduce electromagnetic interference (EMI), the CY27430 supports spread-spectrum modulation. The output clock frequencies can be modulated to spread energy across a broader range of frequencies and lower system EMI. The

CY27430 implements two types of spread profiles for modulation: linear and nonlinear.

The spread spectrum can be applied to any output clock, any frequency, and any spread amount ranging from 0.1% to 5% in 0.1% steps. The center or down spread can be programmable.

The spread modulation rate is limited from 30 kHz to 60 kHz.

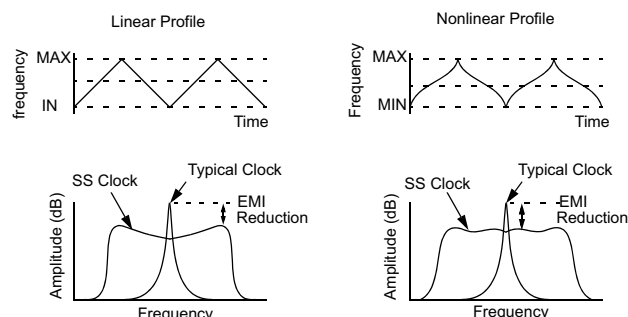
The spread spectrum is generated digitally in the FracN modulation, which means all the parameters are independent of process, voltage, and temperature variations. All the frequencies generated by the same PLL have the same amount of modulation.

As shown in Figure 14, a harmonic of a modulated clock has a much lower amplitude than that of an unmodulated signal. The reduction in amplitude is dependent on the harmonic number and the frequency deviation or spread. The equation for the reduction in the nonlinear profile is:

$$dB = 6.5 + 9 * \log_{10}(P) + 9 * \log_{10}(F)$$

where P is the percentage of deviation and F is the frequency in megahertz where the reduction is measured.

**Figure 14. Spread-Spectrum Profile**



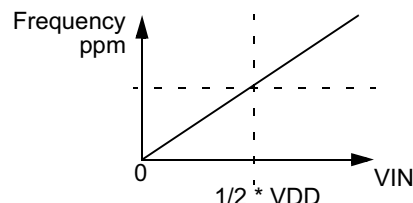
#### VCXO (VCFS) Functionality

The CY27430 supports VCXO functionality without pulling the crystal frequency. This function is implemented by modulating the FracN counter according to the VIN level, as shown in Figure 15. Therefore, this is called voltage-controlled frequency shift (VCFS).

The VCFS function is implemented by modulating the FracN divider, which means all the parameters are independent of the process, voltage, and temperature variations.

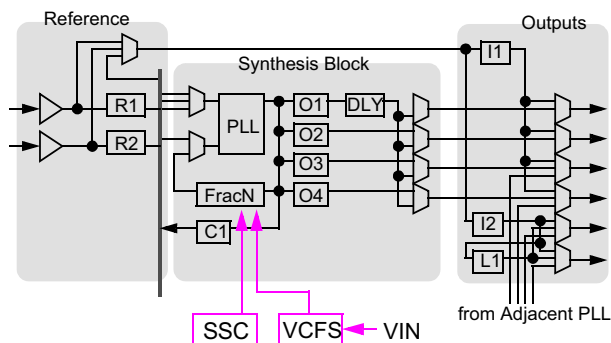
It is not possible to combine the VCFS operation with spread spectrum (see Figure 16).

**Figure 15. VCFS Profile**





**Figure 16. VCFS and Spread Spectrum**



### Crystal Oscillator

The CY27430 supports various low-cost crystals as a reference oscillator at IN1 (XIN/XOUT) to generate multiple frequencies in a single chip. The CY27430 supports a crystal with a nominal load capacitance specification from 8 pF to 12 pF. As shown in [Figure 2 on page 3](#), the CY27430 integrates all the components, such as a feedback resistor and tuning capacitor, to oscillate the clock with a particular crystal for the following specifications.

To enable proper operation, the crystal specification is divided into three ranges:

- Low range ( $F_{NOM}$ ) = 8 to 12 MHz
- Mid range = 12 to 20 MHz
- High range = 20 to 48 MHz

The corresponding crystal parameters are listed in [Table 2](#).

**Table 2. Crystal Specifications**

| Range                                       | Min Frequency (MHz) | Max Frequency (MHz)                         | Max R1 (ohms) | Max DL ( $\mu$ W) |
|---------------------------------------------|---------------------|---------------------------------------------|---------------|-------------------|
| Low                                         | 8                   | 12                                          | 150           | 100               |
| Mid                                         | 12                  | 20                                          | 70            | 100               |
| High                                        | 20                  | 48                                          | 50            | 100               |
| <b><math>C_L</math> (pF) for all Ranges</b> |                     | <b>Associated Max <math>C_0</math> (pF)</b> |               |                   |
| 8                                           |                     | 2                                           |               |                   |
| 9                                           |                     | 2                                           |               |                   |
| 10                                          |                     | 2                                           |               |                   |
| 12                                          |                     | 3                                           |               |                   |

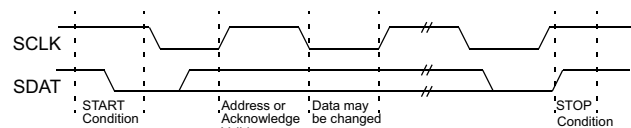
### Serial Programming Interface Protocol

The CY27430 uses the SDAT and SCLK pins for a two-wire serial interface that operates up to 400 Kb/s in Read and Write modes. It complies with the I<sup>2</sup>C bus standard. The basic Write protocol is:

Start Bit; 7-bit Device Address; R/W Bit; Slave Clock Acknowledge (ACK); 8-bit Memory Address (MA); ACK; 8-bit Data in MA+1 if desired; ACK; 8-bit Data in MA+2; ACK; and more until STOP Bit.

The basic serial format is shown in [Figure 17](#).

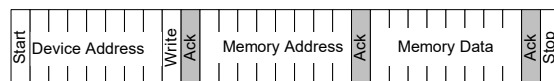
**Figure 17. Data Transfer Sequence on the Serial Bus**



A valid write operation must have a full 8-bit register address after the device address word from the master, which is followed by an acknowledge bit from the slave (SDAT = 0/LOW). The next eight bits must contain the data word intended for storage. After the data word is received, the slave responds with another acknowledge bit (SDAT = 0/LOW), and the master must end the write sequence with a STOP condition (see [Figure 18](#)).

**Figure 18. Data Frame Architecture (Write)**

### Random Write



### Sequential Write





Read operations are initiated the same way as write operations, except that the R/W bit of the slave address is set to '1' (HIGH).

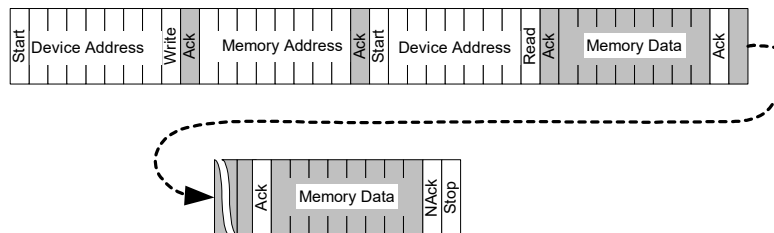
There are two basic read operations: random read and sequential read. Figure 19 illustrates these operations.

**Figure 19. Data Frame Architecture (Read)**

#### Random Read



#### Sequential Read



Through random read operations, the master may access any memory location. To perform this type of read operation, first set the word address. Send the address to the CY27430 as part of a write operation. After the word address is sent, the master generates a START condition following the acknowledge. This terminates the write operation before any data is stored in the address, but not before the internal address pointer is set. Next, the master reissues the control byte with the R/W byte set to '1'.

Then, the CY27430 issues an acknowledge and transmits the 8-bit word. The master device does not acknowledge the transfer, but does generate a STOP condition, which causes the CY27430 to stop transmission.

Sequential read operations follow the same process as random reads, except that the master issues an acknowledge instead of a STOP condition after transmission of the first 8-bit data word. This action results in an incrementing of the internal address pointer, and subsequently output of the next 8-bit data word. By continuing to issue acknowledges instead of STOP conditions, the master may serially read the entire contents of the slave device memory.

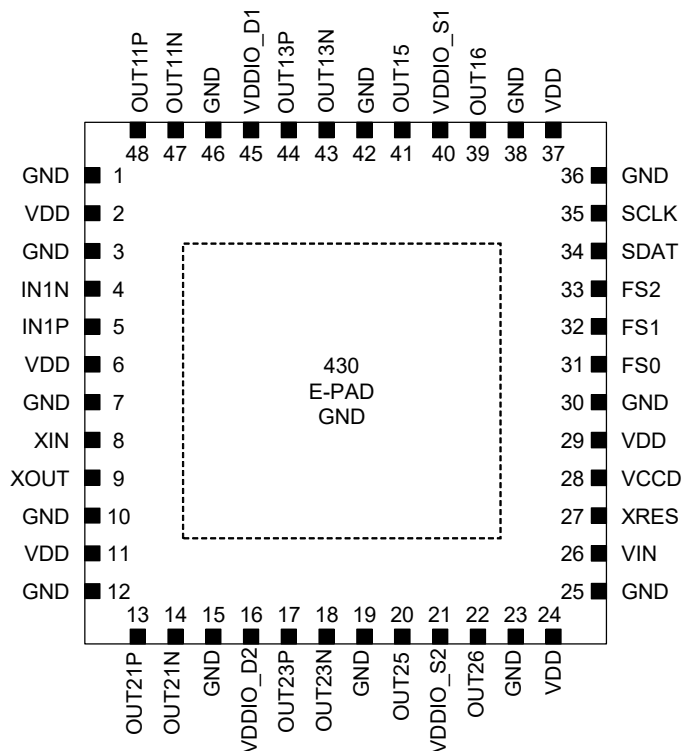
## Pinouts

The CY27430 devices are available in the 48-pin QFN package.

### CY27430 Automotive Pinout

The CY27430 Automotive is the product that has the maximum number of outputs (8) with all the features including I<sup>2</sup>C, and Frequency Select options.

**Figure 20. 48-pin QFN pinout**



## Pin Definitions

**Table 3. 48-pin QFN (CY27430) Pin Definitions**

| Name   | I/O | Type                     | # of Pins | Pin # | Function                                                                                                                  |
|--------|-----|--------------------------|-----------|-------|---------------------------------------------------------------------------------------------------------------------------|
| IN1N   | I   | Differential             | 1         | 4     | Complement input for IN1 differential pair. None for LVCMOS input. Need external series capacitor for differential input. |
| IN1P   | I   | LVCMOS/<br>Differential  | 1         | 5     | True input for IN1 differential pair. IN1 for LVCMOS input. Need external series capacitor for differential input.        |
| XIN    | I   | Crystal                  | 1         | 8     | XIN for crystal                                                                                                           |
| XOUT   | O   | Crystal                  | 1         | 9     | XOUT for crystal                                                                                                          |
| OUT21P | O   | LVCMOS /<br>Differential | 1         | 13    | Output 21 true output (differential) or<br>Output 21 LVCMOS output                                                        |
| OUT21N | O   | Differential             | 1         | 14    | Output 21 complement output (differential). connect to OUT21P for LVCMOS                                                  |
| OUT23P | O   | LVCMOS /<br>Differential | 1         | 17    | Output 23 true output (differential) or<br>Output 23 LVCMOS output                                                        |

**Table 3. 48-pin QFN (CY27430) Pin Definitions** *(continued)*

| Name     | I/O    | Type                  | # of Pins | Pin #                                                      | Function                                                                                                                                          |
|----------|--------|-----------------------|-----------|------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|
| OUT23N   | O      | Differential          | 1         | 18                                                         | Output 23 complement output (differential). connect to OUT23P for LVCMOS                                                                          |
| OUT25    | O      | LVCMOS                | 1         | 20                                                         | LVCMOS clock output 25                                                                                                                            |
| OUT26    | O      | LVCMOS                | 1         | 22                                                         | LVCMOS clock output 26                                                                                                                            |
| VIN      | I      | Analog                | 1         | 26                                                         | Voltage input for ADC                                                                                                                             |
| XRES     | I      | LVCMOS                | 1         | 27                                                         | Active low RESET SIGNAL                                                                                                                           |
| VCCD     | Analog | Analog                | 1         | 28                                                         | For 1.8-V operation, connect to VDD.<br>For 2.5-V or 3.3-V operation, do not connect to VDD; connect a 100-nF capacitor between this pin and GND. |
| FS0      | I      | LVCMOS                | 1         | 31                                                         | Frequency Select pin                                                                                                                              |
| FS1      | I      | LVCMOS                | 1         | 32                                                         | Frequency Select pin                                                                                                                              |
| FS2      | I      | LVCMOS                | 1         | 33                                                         | Frequency Select pin                                                                                                                              |
| SDAT     | I/O    | LVCMOS / Open Drain   | 1         | 34                                                         | I <sup>2</sup> C serial data pin                                                                                                                  |
| SCLK     | I      | LVCMOS                | 1         | 35                                                         | I <sup>2</sup> C clock pin                                                                                                                        |
| OUT16    | O      | LVCMOS                | 1         | 39                                                         | LVCMOS clock output 16                                                                                                                            |
| OUT15    | O      | LVCMOS                | 1         | 41                                                         | LVCMOS clock output 15                                                                                                                            |
| OUT13N   | O      | Differential          | 1         | 43                                                         | Output 13 complement output (differential). connect to OUT13P for LVCMOS                                                                          |
| OUT13P   | O      | LVCMOS / Differential | 1         | 44                                                         | Output 13 complement output (differential) or Output 13 LVCMOS                                                                                    |
| OUT11N   | O      | Differential          | 1         | 47                                                         | Output 11 complement output (differential). connect to OUT11P for LVCMOS                                                                          |
| OUT11P   | O      | LVCMOS / Differential | 1         | 48                                                         | Output 11 complement output (differential) or Output 11 LVCMOS                                                                                    |
| VDDIO_D1 | PWR    | PWR                   | 1         | 45                                                         | Output power supply for Bank1 OUT11,13 outputs                                                                                                    |
| VDDIO_S1 | PWR    | PWR                   | 1         | 40                                                         | Output power supply for Bank1 OUT15,16 outputs                                                                                                    |
| VDDIO_D2 | PWR    | PWR                   | 1         | 16                                                         | Output power supply for Bank2 OUT21, 23 outputs                                                                                                   |
| VDDIO_S2 | PWR    | PWR                   | 1         | 21                                                         | Output power supply for Bank2 OUT25, 26outputs                                                                                                    |
| VDD      | PWR    | PWR                   | 6         | 2, 6, 11, 24, 29, 37                                       | Core power supply                                                                                                                                 |
| GND      | GND    | GND                   | 15        | 1, 3, 7, 10, 12, 15, 19, 23, 25, 30, 36, 38, 42, 46, E-PAD | Supply ground                                                                                                                                     |

## Electrical Specifications

Exceeding maximum ratings may shorten the useful life of the device.

### Absolute Maximum Ratings

**Table 4. Absolute Maximum Ratings**

| Symbol        | Description                              | Conditions                                                                                                                  | Min  | Typ   | Max            | Units |
|---------------|------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|------|-------|----------------|-------|
| $V_{DD}$      | Core supply voltage                      |                                                                                                                             | -0.5 | —     | 4.6            | V     |
| $V_{DDIOX}$   | Output bank supply voltage               |                                                                                                                             | -0.5 | —     | 4.6            | V     |
| $V_{IN}$      | Input voltage                            | Relative to $V_{SS}$                                                                                                        | -0.5 | —     | $V_{DD} + 0.4$ | V     |
| $V_{IN2C}$    | I2C Bus input voltage                    | SCLK, SDAT pins                                                                                                             | -0.5 | —     | 6              | V     |
| $T_S$         | Storage temperature                      | Non functional                                                                                                              | -55  | —     | +150           | °C    |
| $ESD_{HBM}$   | ESD (human body model)                   | JEDEC JS-001-2012                                                                                                           | 2000 | —     | —              | V     |
| $ESD_{CDM}$   | ESD (charged device model)               | JEDEC JESD22-C101E                                                                                                          | 500  | —     | —              | V     |
| $ESD_{MM}$    | ESD (machine model)                      | JEDEC JESD22-A115B                                                                                                          | 200  | —     | —              | V     |
| LU            | Latchup                                  | JEDEC JESD78D                                                                                                               | —    | —     | 140            | mA    |
| UL-94         | Flammability rating                      | V-0 at 1/8 in                                                                                                               | —    | —     | 10             | ppm   |
| MSL           | Moisture sensitivity level               |                                                                                                                             | —    | 3     | —              |       |
| $\theta_{JA}$ | Thermal Resistance (junction to ambient) | Test conditions follow standard test methods and procedures for measuring thermal impedance, in accordance with EIA/JESD51. | —    | 15.22 | —              | °C/W  |
| $\theta_{JC}$ | Thermal Resistance (junction to case)    |                                                                                                                             | —    | 2.21  | —              | °C/W  |

### Operating Temperature

**Table 5. Operating Temperature**

| Symbol | Description          | Conditions         | Min | Typ | Max  | Units |
|--------|----------------------|--------------------|-----|-----|------|-------|
| $T_A$  | Ambient temperature  | Automotive-A Grade | -40 | —   | +85  | °C    |
| $T_J$  | Junction temperature | Automotive-A Grade | -40 | —   | +100 | °C    |
| $T_A$  | Ambient temperature  | Automotive-S Grade | -40 | —   | +105 | °C    |
| $T_J$  | Junction temperature | Automotive-S Grade | -40 | —   | +120 | °C    |

## Operating Power Supply

**Table 6. Operating Power Supply**

| Symbol         | Description                                | Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                                           | Min  | Typ  | Max  | Units |
|----------------|--------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|-------|
| $V_{DD}$       | Core supply voltage                        | 1.8-V range: $\pm 5\%$                                                                                                                                                                                                                                                                                                                                                                                                                                               | 1.71 | 1.80 | 1.89 | V     |
|                |                                            | 2.5-V range: $\pm 10\%$                                                                                                                                                                                                                                                                                                                                                                                                                                              | 2.25 | 2.50 | 2.75 | V     |
|                |                                            | 3.3-V range: 5%                                                                                                                                                                                                                                                                                                                                                                                                                                                      | 3.13 | 3.3  | 3.46 | V     |
| $V_{DDIO}$     | Output supply voltage                      | 1.8-V range: $\pm 5\%$                                                                                                                                                                                                                                                                                                                                                                                                                                               | 1.71 | 1.80 | 1.89 | V     |
|                |                                            | 2.5-V range: $\pm 10\%$                                                                                                                                                                                                                                                                                                                                                                                                                                              | 2.25 | 2.50 | 2.75 | V     |
|                |                                            | 3.3-V range: 5%                                                                                                                                                                                                                                                                                                                                                                                                                                                      | 3.13 | 3.30 | 3.46 | V     |
| $I_{DDO}$      | Power supply current per pair              | LVPECL, output pair terminated 50 $\Omega$ to $V_{TT}$ ( $V_{DD} - 2$ V)                                                                                                                                                                                                                                                                                                                                                                                             | –    | –    | 38.0 | mA    |
|                |                                            | LVPECL, output pair terminated 50 $\Omega$ to $V_{TT}$ ( $V_{DD} - 1.7$ V)                                                                                                                                                                                                                                                                                                                                                                                           | –    | –    | 28   | mA    |
| $I_{DDO}$      | Power supply current per pair              | LVDS, output pair terminated 100 $\Omega$                                                                                                                                                                                                                                                                                                                                                                                                                            | –    | –    | 14   | mA    |
| $I_{DDO}$      | Power supply current per pair              | HCSL, output pair terminated 33 $\Omega$ to 49.9 $\Omega$ to GND                                                                                                                                                                                                                                                                                                                                                                                                     | –    | –    | 28   | mA    |
| $I_{DDO}$      | Power supply current per pair              | CML, output pair terminated 50 $\Omega$ to $V_{DD}$                                                                                                                                                                                                                                                                                                                                                                                                                  | –    | –    | 18.0 | mA    |
| $I_{DDO}$      | Power supply current per pair              | CMOS, 10-pF load, 33 MHz                                                                                                                                                                                                                                                                                                                                                                                                                                             | –    | –    | 6.0  | mA    |
| $I_{DDPLL1}$   | Current consumption per PLL                | Includes DIVC                                                                                                                                                                                                                                                                                                                                                                                                                                                        | –    | –    | 28   | mA    |
| $I_{DDXO}$     | XO/Input block current consumption         | XO or IN1 input buffer on                                                                                                                                                                                                                                                                                                                                                                                                                                            | –    | –    | 3.5  | mA    |
| $I_{DDPM}$     | Power management block current consumption |                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | –    | –    | 2.5  | mA    |
| $t_{LOCK}$     | Device power-up time                       | Time from minimum specified $V_{DD}$ to Output Stable in XO-based clock gen mode. In the case of external clock input, $t_{LOCK}$ will reduce by the crystal oscillator startup time ( $t_{OSCSTART}$ ). This specification is valid when the reference is available and stable at startup. For supply ramps slower than the $t_{PU\_SR}$ spec where customers use XRES during power up. Power-up time will be calculated from the release of XRES to output stable. | –    | –    | 10   | ms    |
| $t_{OSCSTART}$ | Crystal oscillator startup time            | Time from crystal oscillator power up to crystal oscillator stable. Crystal FNOM=25MHz, C1>1fF                                                                                                                                                                                                                                                                                                                                                                       |      |      | 4    | ms    |
| $t_{PU\_SR}$   | Power supply slew rate during power up     | Power-supply ramp rate for $V_{DD}$ to reach minimum specified voltage (power ramp must be monotonic). For supply ramps slower than 1 V/ms, use XRES to externally keep the part in RESET during power-up and release XRES after $V_{DD}$ reaches the minimum specification.                                                                                                                                                                                         | 1    | –    | 67   | V/ms  |

## DC Chip-Level Specifications

**Table 7. DC Electrical Specifications Input**

| Symbol        | Description                    | Conditions                                                 | Min  | Typ | Max  | Units         |
|---------------|--------------------------------|------------------------------------------------------------|------|-----|------|---------------|
| $V_{IH33}$    | Input high voltage             | LVTMOS and logic inputs, $V_{DD} = 3.3\text{ V}$           | 2.0  | —   | —    | V             |
| $V_{IH25}$    | Input high voltage             | LVTMOS and logic inputs, $V_{DD} = 2.5\text{ V}$           | 1.7  | —   | —    | V             |
| $V_{IH18}$    | Input high voltage             | LVTMOS and logic inputs, $V_{DD} = 1.8\text{ V}$           | 1.1  | —   | —    | V             |
| $V_{IL33}$    | Input low voltage              | LVTMOS and logic inputs, $V_{DD} = 3.3\text{ V}$           | —    | —   | 0.8  | V             |
| $V_{IL25}$    | Input low voltage              | LVTMOS and logic inputs, $V_{DD} = 2.5\text{ V}$           | —    | —   | 0.7  | V             |
| $V_{IL18}$    | Input low voltage              | LVTMOS and logic inputs, $V_{DD} = 1.8\text{ V}$           | —    | —   | 0.5  | V             |
| $V_{DIFF}$    | Differential input             | LVDS, CML, PECL, HCSL. Differential amplitude, pk.         | 0.30 | —   | 1.45 | V             |
| $DC_{DIFF}$   | Duty cycle, differential input | Measured at crossing point                                 | 40   | 50  | 60   | %             |
| $DC_{LVTMOS}$ | Duty cycle, LVTMOS input       | Measured at $1/2 V_{DD}$                                   | 40   | 50  | 60   | %             |
| $I_{IH}$      | Input high current             | Input = $V_{DD}$                                           | —    | —   | 150  | $\mu\text{A}$ |
| $I_{IL}$      | Input low current              | Input = GND                                                | –150 | —   | —    | $\mu\text{A}$ |
| $C_{IN}$      | Input capacitance (IN1)        | Measured at 10 MHz, differential                           | —    | —   | 3.0  | pF            |
| $V_{PPSINE}$  | AC input swing pk              | Clipped sine wave, AC coupled through a 1000-pF capacitor. | 0.8  | 1.0 | 1.2  | V             |
| $R_P$         | Input Pull-down resistance     | LVTMOS clock (IN1) input                                   | 75   | 115 | 170  | k $\Omega$    |

## DC Output Specifications

**Table 8. DC Specifications for LVTMOS Output**

| Symbol   | Description         | Conditions | Min              | Typ | Max | Units |
|----------|---------------------|------------|------------------|-----|-----|-------|
| $V_{OH}$ | Output high voltage | 4 mA load  | $V_{DDIO} - 0.3$ | —   | —   | V     |
| $V_{OL}$ | Output low voltage  | 4 mA load  | —                | —   | 0.3 | V     |

**Table 9. DC Specifications for LVDS Output ( $V_{DDIO} = 2.5\text{ V}$  or  $3.3\text{ V}$  range)**

| Symbol           | Description                                             | Conditions                                                        | Min   | Typ   | Max   | Units         |
|------------------|---------------------------------------------------------|-------------------------------------------------------------------|-------|-------|-------|---------------|
| $V_{PP}$         | LVDS output AC single-ended pk-pk,                      | 8 MHz to 325 MHz                                                  | 250   | —     | 510   | mV            |
| $V_{PP}$         | LVDS output AC single-ended pk-pk                       | 325 MHz to 700 MHz                                                | 200   | —     | 510   | mV            |
| $\Delta V_{PP}$  | Change in $V_{PP}$ between complementary output states  |                                                                   | —     | —     | 50    | mV            |
| $V_{OCM}$        | Output common-mode voltage                              | Met only at 2.5 V and 3.3 V. Need AC coupling for 1.8-V operation | 1.075 | 1.250 | 1.425 | V             |
| $\Delta V_{OCM}$ | Change in $V_{OCM}$ between complementary output states |                                                                   | —     | —     | 50    | mV            |
| $I_{OZ}$         | Output leakage current                                  | Output off, $V_{OUT} = 0.75\text{ V}$ to $1.75\text{ V}$          | –20   | —     | 20    | $\mu\text{A}$ |

**Table 10. DC Specifications for LVPECL Output ( $V_{DDIO} = 2.5\text{ V}$  or  $3.3\text{ V}$  range)**

| Symbol   | Description                          | Conditions                                                      | Min                | Typ | Max                | Units |
|----------|--------------------------------------|-----------------------------------------------------------------|--------------------|-----|--------------------|-------|
| $V_{OH}$ | Output high voltage                  | R-term = $50\ \Omega$ to $V_{TT}$ ( $V_{DDIO} - 2.0\text{ V}$ ) | $V_{DDIO} - 1.165$ | –   | $V_{DDIO} - 0.800$ | V     |
| $V_{OL}$ | Output low voltage                   | R-term = $50\ \Omega$ to $V_{TT}$ ( $V_{DDIO} - 2.0\text{ V}$ ) | $V_{DDIO} - 2.0$   | –   | $V_{DDIO} - 1.620$ | V     |
| $V_{PP}$ | LVPECL output AC single ended pk-pk, | $f_{OUT} = 8\text{ MHz to }150\text{ MHz}$                      | 450                | –   | –                  | mV    |
|          |                                      | $f_{OUT} = 150\text{ MHz to }700\text{ MHz}$                    | 320                | –   | –                  | mV    |

**Table 11. DC Specifications for CML Output ( $V_{DDIO} = 2.5\text{ V}$  or  $3.3\text{ V}$  range)**

| Symbol   | Description                      | Conditions                                 | Min              | Typ | Max              | Units |
|----------|----------------------------------|--------------------------------------------|------------------|-----|------------------|-------|
| $V_{OH}$ | Output high voltage              | R-term = $50\ \Omega$ to $V_{DDIO}$        | $V_{DDIO} - 0.1$ | –   | –                | V     |
| $V_{OL}$ | Output low voltage               | R-term = $50\ \Omega$ to $V_{DDIO}$        | $V_{DDIO} - 0.7$ | –   | $V_{DDIO} - 0.3$ | V     |
| $V_{PP}$ | CML output AC single-ended pk-pk | $f_{OUT} = 8\text{ MHz to }150\text{ MHz}$ | 250              | –   | 700              | mV    |
| $V_{PP}$ | CML output AC single-ended pk-pk | $150 < f_{OUT} < 700\text{ MHz}$           | 200              | –   | 600              | mV    |

**Table 12. DC Specifications for HCSL Output ( $V_{DDIO} = 2.5\text{ V}$  or  $3.3\text{ V}$  range)**

| Symbol           | Description                                          | Conditions                                   | Min | Typ | Max  | Units |
|------------------|------------------------------------------------------|----------------------------------------------|-----|-----|------|-------|
| $V_{OCM}$        | Output common mode voltage                           | Common mode                                  | 350 | –   | 400  | mV    |
| $V_{OHDIFF}$     | Differential output high voltage                     | Measurement taken from differential waveform | 150 | –   | –    | mV    |
| $V_{OLDIFF}$     | Differential output low voltage                      | Measurement taken from differential waveform | –   | –   | –150 | mV    |
| $V_{CROSS}$      | Absolute crossing point voltage                      | Measurement taken from single-ended waveform | 250 | –   | 550  | mV    |
| $V_{CROSSDELTA}$ | Variation of $V_{CROSS}$ over all rising clock edges | Measurement taken from single-ended waveform | –   | –   | 140  | mV    |

**Table 13. Input Frequency Range**

| Symbol          | Description                        | Conditions                                      | Min | Typ | Max | Units |
|-----------------|------------------------------------|-------------------------------------------------|-----|-----|-----|-------|
| $F_{CRYSTAL}$   | Crystal frequency                  | Fundamental AT CUT crystal                      | 8   | –   | 48  | MHz   |
| $F_{REFERENCE}$ | Reference frequency                | Internal reference to PLL                       | 8   | –   | 40  | MHz   |
| $F_{INCMOS}$    | LVC MOS input frequency            | Buffer mode, all PLLs OFF                       | 8   | –   | 250 | MHz   |
| $F_{INCMOS}$    | LVC MOS input frequency            | Buffer mode, one or more PLL active             | 8   | –   | 125 | MHz   |
| $F_{INCMOS}$    | LVC MOS input frequency            | CLKGEN mode                                     | 8   | –   | 250 | MHz   |
| $F_{INDIFF}$    | Differential clock input frequency | Buffer mode, all PLLs OFF                       | 8   | –   | 700 | MHz   |
| $F_{INDIFF}$    | Differential clock input frequency | Buffer mode, one or more PLL active             | 8   | –   | 125 | MHz   |
| $F_{INDIFF}$    | Differential clock input frequency | CLKGEN mode                                     | 8   | –   | 300 | MHz   |
| $F_{INCAS}$     | Cascading clock frequency          | Internal cascading frequency in the Buffer mode | 8   | –   | 125 | MHz   |



## AC Input Clock Specifications

**Table 14. AC Input Clock Electrical Specification**

| Symbol              | Description                   | Conditions                                          | Min | Typ | Max | Units |
|---------------------|-------------------------------|-----------------------------------------------------|-----|-----|-----|-------|
| $t_{\text{CMOSDC}}$ | LVC MOS input duty cycle      | Measured at $1/2 V_{\text{DD}}$ 20%–80%, Functional | 40  | 50  | 60  | %     |
| $t_{\text{DIFFDC}}$ | Differential input duty cycle | Measured at $V_{\text{OCM}}$ 20%–80%, Functional    | 40  | 50  | 60  | %     |
| $t_{\text{RFCMOS}}$ | LVC MOS input rise/fall time  | Measured between 20%–80% of $V_{\text{DD}}$         | –   | –   | 4   | ns    |

## AC Output Specifications

**Table 15. AC Electrical Specifications LVC MOS Output. Load: 15 pF < 100 MHz, 7.5 pF < 200 MHz, 5 pF > 200 MHz**

| Symbol                                     | Description               | Conditions                                                                                                                                                                                             | Min   | Typ | Max | Units |
|--------------------------------------------|---------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-----|-----|-------|
| <b>Common AC Electrical Specifications</b> |                           |                                                                                                                                                                                                        |       |     |     |       |
| $t_{\text{RFCMOS}}$                        | Rise/fall time            | $f_{\text{OUT}} < 100\text{MHz}$ , 20%–80%                                                                                                                                                             | –     | –   | 2.0 | ns    |
| $t_{\text{RFCMOS}}$                        | Rise/fall time            | $f_{\text{OUT}} < 200\text{MHz}$ , 20%–80%                                                                                                                                                             | –     | –   | 1.5 | ns    |
| $t_{\text{RFCMOS}}$                        | Rise/fall time            | $f_{\text{OUT}} < 250\text{MHz}$ , 20%–80%                                                                                                                                                             | –     | –   | 1.3 | ns    |
| $t_{\text{SKEW}}$                          | Output to output skew     | Equally loaded, measured at $1/2 V_{\text{IOX}}$ , in a bank, derived from the same PLL,                                                                                                               | –     | –   | 150 | ps    |
| <b>Buffer Mode</b>                         |                           |                                                                                                                                                                                                        |       |     |     |       |
| $f_{\text{OUT}}$                           | Output frequency          | All PLLs off                                                                                                                                                                                           | 8     |     | 250 | MHz   |
| $f_{\text{OUT}}$                           | Output frequency          | With one or more PLL running                                                                                                                                                                           | 8     |     | 125 | MHz   |
| $t_{\text{DC}}$                            | Output duty cycle         | Measured at $1/2 V_{\text{IOX}}$ , Input DC = 50%                                                                                                                                                      | 40    | 50  | 60  | %     |
| $t_{\text{JIT\_ADD}}$                      | Additive RMS phase jitter | $f_{\text{OUT}} = 156.25\text{ MHz}$ , 12k-20 MHz offset, DIV1 = 1. Input slew rate 1.8 V/ns, 20%–80% $V_{\text{DD}}$                                                                                  | –     | 0.7 | 2.0 | ps    |
| $t_{\text{DELAY}}$                         | Propagation delay         | Input to output delay                                                                                                                                                                                  | –     | –   | 7.0 | ns    |
| <b>CLKGEN Mode</b>                         |                           |                                                                                                                                                                                                        |       |     |     |       |
| $f_{\text{OUT}}$                           | Output frequency          |                                                                                                                                                                                                        | 3     | –   | 250 | MHz   |
| $f_{\text{OUTL}}$                          | Low frequency output      | 1 kHz is supported when the max input frequency to DIV1 is 48 MHz                                                                                                                                      | 0.001 | –   | 50  | MHz   |
| $t_{\text{DC}}$                            | Output duty cycle         | Measured at $1/2 V_{\text{IOX}}$ , $f_{\text{OUT}} > 200\text{ MHz}$ , $V_{\text{DDIO}} = 2.5\text{ V}$ or $3.3\text{ V}$ . $f_{\text{OUT}} > 100\text{ MHz}$ , $V_{\text{DDIO}} = 1.8\text{ V}$       | 40    | 50  | 60  | %     |
| $t_{\text{DC}}$                            | Output duty cycle         | Measured at $1/2 V_{\text{IOX}}$ , $f_{\text{OUT}} \leq 200\text{ MHz}$ , $V_{\text{DDIO}} = 2.5\text{ V}$ or $3.3\text{ V}$ . $f_{\text{OUT}} \leq 100\text{ MHz}$ , $V_{\text{DDIO}} = 1.8\text{ V}$ | 45    | –   | 55  | %     |
| $t_{\text{CCJ}}$                           | Cycle-to-cycle jitter     | pk, measured at $1/2 V_{\text{IOX}}$ over 10k cycle, $f_{\text{OUT}} = 100\text{ MHz}$ . Configuration dependent                                                                                       | –     | –   | 50  | ps    |
| $t_{\text{PJ}}$                            | Period jitter             | pk-pk, measured at $1/2 V_{\text{IOX}}$ over 10k cycle, $f_{\text{OUT}} = 100\text{ MHz}$ . Input reference 25-MHz crystal. Configuration dependent                                                    | –     | –   | 100 | ps    |
| <b>SSC Mode</b>                            |                           |                                                                                                                                                                                                        |       |     |     |       |
| $f_{\text{OUT}}$                           | Output frequency          |                                                                                                                                                                                                        | 3     | –   | 250 | MHz   |
| $t_{\text{DC}}$                            | Output duty cycle         | Measured at $1/2 V_{\text{IOX}}$ , $f_{\text{OUT}} > 200\text{ MHz}$ , $V_{\text{DDIO}} = 2.5\text{ V}$ or $3.3\text{ V}$ . $f_{\text{OUT}} > 100\text{ MHz}$ , $V_{\text{DDIO}} = 1.8\text{ V}$       | 40    | 50  | 60  | %     |

**Table 15. AC Electrical Specifications LVCMOS Output. Load: 15 pF < 100 MHz, 7.5 pF < 200 MHz, 5 pF > 200 MHz (continued)**

| Symbol    | Description           | Conditions                                                                                                                                         | Min | Typ | Max | Units |
|-----------|-----------------------|----------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|-------|
| $t_{DC}$  | Output duty cycle     | Measured at $1/2 V_{IOX}$ ,<br>$f_{OUT} \leq 200$ MHz $V_{DDIO} = 2.5$ V or 3.3 V.<br>$f_{OUT} \leq 100$ MHz, $V_{DDIO} = 1.8$ V                   | 45  | 50  | 55  | %     |
| $t_{CCJ}$ | Cycle-to-cycle jitter | pk, measured at $1/2 V_{IOX}$ over 10-k cycle, $f_{OUT} = 100$ MHz, with a spread of 0.5%. Input reference 25 MHz crystal. Configuration dependent | –   | –   | 100 | ps    |

**Table 16. AC Electrical Specifications, Differential Output (LVPECL, CML, LVDS) <sup>[1]</sup>**

| Symbol                                     | Description                   | Conditions                                                                                                                                    | Min | Typ | Max  | Units  |
|--------------------------------------------|-------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|------|--------|
| <b>COMMON AC Electrical Specifications</b> |                               |                                                                                                                                               |     |     |      |        |
| $t_{RF}$                                   | PECL output rise/fall time    | 20%–80% of AC levels, measured at 622.08 MHz                                                                                                  | –   | –   | 450  | ps     |
| $t_{RF}$                                   | CML output rise/fall time     | 20%–80% of AC levels, measured at 622.08 MHz                                                                                                  | –   | –   | 450  | ps     |
| $t_{RF}$                                   | LVDS output rise/fall time    | 20%–80% of AC levels, measured at 622.08 MHz                                                                                                  | –   | –   | 450  | ps     |
| $t_{SK1}$                                  | Output skew                   | Four differential output pairs in a bank, derived from the same PLL, with same standard and load conditions                                   | –   | –   | 100  | ps     |
| <b>BUFFER Mode</b>                         |                               |                                                                                                                                               |     |     |      |        |
| $t_{ODC}$                                  | Output duty cycle             | Differential input signal at 50% duty cycle, differential signal, 622.08 MHz                                                                  | 40  | 50  | 60   | %      |
| $t_{ODC}$                                  | Output duty cycle             | LVCMOS input signal at 50% duty cycle, differential signal, 250 MHz                                                                           | 40  | 50  | 60   | %      |
| $t_{PD}$                                   | Propagation delay             | Measured at differential signal, 156.25 MHz                                                                                                   | –   | –   | 4    | ns     |
| $t_{JIT\_ADD}$                             | Additive RMS phase jitter     | $f_{OUT} = 156.25$ MHz, 12 kHz to 20 MHz offset, DIV1 = 1. Input slew rate 4 V/ns differential, 400-mV amplitude.                             | –   | –   | 400  | fs     |
| <b>CLKGEN Mode</b>                         |                               |                                                                                                                                               |     |     |      |        |
| $t_{ODC}$                                  | Output duty cycle             | Measured at differential signal, 622.08 MHz                                                                                                   | 45  | 50  | 55   | %      |
| $t_{CCJ}$                                  | Cycle-to-cycle jitter         | pk, measured at differential signal, 156.25 MHz, over 10k cycles. Input frequency (24 MHz to 40 MHz) crystal. (all differential outputs on)   | –   | –   | 50   | ps     |
| $t_{PJ}$                                   | Period jitter                 | pk-pk, measured at differential signal 156.25 MHz, over 10k cycles. Input frequency (24 MHz to 40 MHz) crystal. (all differential outputs on) | –   | –   | 50   | ps     |
| $t_{JRMS}$                                 | RMS phase jitter              | $f_{OUT} = 156.25$ MHz, 12kHz to 20 MHz offset                                                                                                | –   | 0.7 | 2.0  | ps     |
| PNg10k                                     | Phase noise, offset = 10 kHz  | $f_{OUT} = 156.25$ MHz. Input reference 25 MHz crystal                                                                                        | –   | –   | –110 | dBc/Hz |
| PNg100k                                    | Phase noise, offset = 100 kHz | $f_{OUT} = 156.25$ MHz. Input reference 25 MHz crystal                                                                                        | –   | –   | –119 | dBc/Hz |

**Note**

1. AC parameters for differential outputs are guaranteed for only differential outputs. LVCMOS is Off.

**Table 16. AC Electrical Specifications, Differential Output (LVPECL, CML, LVDS) <sup>[1]</sup> (continued)**

| Symbol          | Description                  | Conditions                                                                                                                                                         | Min | Typ | Max  | Units  |
|-----------------|------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|------|--------|
| PNg1M           | Phase noise, offset = 1 MHz  | $f_{OUT} = 156.25$ MHz. Input reference 25 MHz crystal                                                                                                             | –   | –   | –131 | dBc/Hz |
| PNg10M          | Phase noise, offset = 10 MHz | $f_{OUT} = 156.25$ MHz. Input reference 25 MHz crystal                                                                                                             | –   | –   | –147 | dBc/Hz |
| PN-SPUR         | Spur                         | At frequency offsets equal to and greater than the update rate of the PLL                                                                                          | –   | –   | –65  | dBc/Hz |
| <b>SSC Mode</b> |                              |                                                                                                                                                                    |     |     |      |        |
| $t_{CCJ}$       | Cycle-to-cycle jitter        | pk, measured at differential signal, 156.25 MHz, over 10k cycles. Input frequency (24 MHz to 40 MHz) crystal, with a spread of 0.5% (all differential outputs on). | –   | –   | 70   | ps     |

**Note**

1. AC parameters for differential outputs are guaranteed for only differential outputs. LVCMOS is Off.

**Table 17. AC Electrical Specification HSCL Output <sup>[2, 3]</sup>**

| Symbol                                     | Description                            | Conditions                                                                                           | Min   | Typ | Max    | Units    |
|--------------------------------------------|----------------------------------------|------------------------------------------------------------------------------------------------------|-------|-----|--------|----------|
| <b>Common AC Electrical Specifications</b> |                                        |                                                                                                      |       |     |        |          |
| $f_{OC}$                                   | Output frequency                       | HCSL                                                                                                 | 96    | –   | 400    | MHz      |
| $E_R$                                      | Rising edge rate                       | Measurement taken from differential waveform, –150 mV to +150 mV                                     | 0.6   | –   | 4      | V/ns     |
| $E_F$                                      | Falling edge rate                      | Measurement taken from differential waveform, –150 mV to +150 mV                                     | 0.6   | –   | 4      | V/ns     |
| $T_{STABLE}$                               | Time before $V_{RB}$ is allowed        | Measurement taken from differential waveform, –150 mV to +150 mV                                     | 500   | –   | –      | ps       |
| $T_{PERIOD\_AVG}$                          | Average clock period accuracy, 100 MHz | Measurement taken from differential waveform, Spread Spectrum On, 0.5% down spread                   | –300  | –   | 2800   | ppm      |
| $T_{PERIOD\_ABS}$                          | Absolute period, 100MHz                | Measurement taken from differential waveform, Spread Spectrum On, 0.5% down spread                   | 9.874 | –   | 10.203 | ns       |
| $R-F_{MATCHING}$                           | Rise-fall matching                     | Measurement taken from single-ended waveform. Rising edge rate to falling edge rate matching 100 MHz | –20   | –   | +20    | %        |
| <b>BUFFER Mode</b>                         |                                        |                                                                                                      |       |     |        |          |
| $T_{DC}$                                   | Duty cycle                             | Measurement taken from differential waveform                                                         | 45    | 50  | 55     | %        |
| $t_{RMS\_ADD}$                             | Additive phase noise                   | Input slew rate 4 V/ns differential 400 mV amplitude.                                                | –     | –   | 0.4    | ps (RMS) |
| <b>CLKGEN Mode</b>                         |                                        |                                                                                                      |       |     |        |          |

**Notes**

2. AC parameters for differential outputs are guaranteed for only differential outputs. LVCMOS is Off.
3. All output clocks 100MHz HCSL format. Jitter is from PCIE jitter filter combination that produces the highest jitter.

**Table 17. AC Electrical Specification HSCL Output** <sup>[2, 3]</sup> (continued)

| Symbol                | Description                           | Conditions                                                                                                                            | Min | Typ | Max | Units |
|-----------------------|---------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|-------|
| T <sub>DC</sub>       | Duty cycle                            | Measurement taken from differential waveform                                                                                          | 45  | 50  | 55  | %     |
| T <sub>CCJITTER</sub> | Cycle-to-cycle jitter                 | pk, measured at differential signal, 100 MHz, over 10k cycles. Input frequency (24 MHz–40 MHz) crystal (all differential outputs on). | –   | –   | 50  | ps    |
| J <sub>RMS</sub>      | Random jitter PCIe 2.0 Common clocked | REF = 25-MHz crystal, f <sub>OUT</sub> = 100 MHz, PCIe Gen2 filters                                                                   | –   | 1.0 | 3.0 | ps    |

**Notes**

2. AC parameters for differential outputs are guaranteed for only differential outputs. LVCMOS is Off.
3. All output clocks 100MHz HCSL format. Jitter is from PCIe jitter filter combination that produces the highest jitter.

**Table 18. AC I<sup>2</sup>C Specifications**

| Symbol              | Description                                     | Conditions | Min | Typ | Max | Units |
|---------------------|-------------------------------------------------|------------|-----|-----|-----|-------|
| f <sub>SCK</sub>    | SCK clock frequency                             |            | 0   | –   | 400 | kHz   |
| t <sub>HD:STA</sub> | Hold time START condition                       |            | 0.6 | –   | –   | μs    |
| t <sub>LOW</sub>    | Low period of the SCK clock                     |            | 1.3 | –   | –   | μs    |
| t <sub>HIGH</sub>   | High period of the SCK clock                    |            | 0.6 | –   | –   | μs    |
| t <sub>SU:STA</sub> | Setup time for a repeated START condition       |            | 0.6 | –   | –   | μs    |
| t <sub>HD:DAT</sub> | Data hold time                                  |            | 0   | –   | –   | μs    |
| t <sub>SU:DAT</sub> | Data setup time                                 |            | 100 | –   | –   | ns    |
| t <sub>R</sub>      | Rise time                                       |            | –   | –   | 300 | ns    |
| t <sub>F</sub>      | Fall time                                       |            | –   | –   | 300 | ns    |
| t <sub>SU:STO</sub> | Setup time for STOP condition                   |            | 0.6 | –   | –   | μs    |
| t <sub>BUF</sub>    | Bus-free time between STOP and START conditions |            | 1.3 | –   | –   | μs    |

**Table 19. Spread-Spectrum Specifications**

| Symbol           | Description            | Conditions | Min | Typ | Max | Units |
|------------------|------------------------|------------|-----|-----|-----|-------|
| F <sub>MOD</sub> | Modulation rate        |            | 30  | –   | 60  | kHz   |
| SSper            | Spread spectrum amount | Total %    | 0.1 | –   | 5.0 | %     |
| SSStep           | Spread spectrum% step  |            | –   | 0.1 | –   | %     |

**Table 20. Output Selection Specifications**

| Symbol    | Description              | Conditions                                                                                       | Min | Typ | Max  | Units   |
|-----------|--------------------------|--------------------------------------------------------------------------------------------------|-----|-----|------|---------|
| $t_{FS}$  | Frequency switching time | Frequency switching time for OUT13, 14, 23, 24. Both PLLs are active (change MUX selection Bit). | –   | –   | 500  | $\mu s$ |
| $t_{FS}$  | Frequency switching time | Frequency switching time for all outputs, DIVO value change                                      | –   | –   | 500  | $\mu s$ |
| $t_{FS}$  | Frequency switching time | Frequency switching time for all outputs. PLL value change.                                      | –   | –   | 1000 | $\mu s$ |
| $t_{FS}$  | Output turn-on time      | Output turn-on time from FS. PLL is active, change OE or MUX.                                    | –   | –   | 500  | $\mu s$ |
| $t_{FS}$  | Output turn-on time      | Output turn-on time from FS. Resume PLL from Power Down.                                         | –   | –   | 1000 | $\mu s$ |
| $t_{OFF}$ | Output turn-off time     | Output turn-off time from FS. PLL is active, change OE or MUX.                                   | –   | –   | 500  | $\mu s$ |

**Table 21. NV Memory Specification**

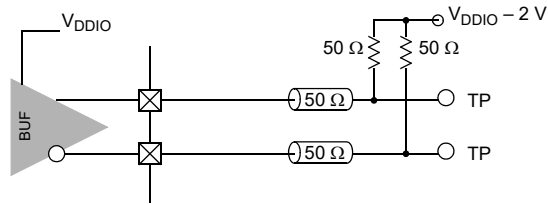
| Symbol                | Description              | Conditions                      | Min   | Typ | Max | Units |
|-----------------------|--------------------------|---------------------------------|-------|-----|-----|-------|
| DRET                  | NV memory data retention |                                 | 10    | –   | –   | Years |
| PROG <sub>CYCLE</sub> | Programming cycle        | Programming cycle for NV memory | 100 K | –   | –   | Cycle |

**Table 22. Miscellaneous Specifications**

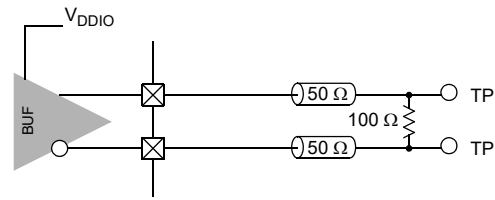
| Symbol      | Description                   | Conditions | Min | Typ | Max | Units       |
|-------------|-------------------------------|------------|-----|-----|-----|-------------|
| $t_{XRES}$  | XRES Low time                 |            | 10  | –   | –   | $\mu s$     |
| $T_{PROG}$  | Flash programming temperature |            | 5   | –   | 55  | $^{\circ}C$ |
| $C_{INADC}$ | Input capacitance VIN pin     |            | –   | –   | 10  | pF          |

## Test and Measurement Circuits

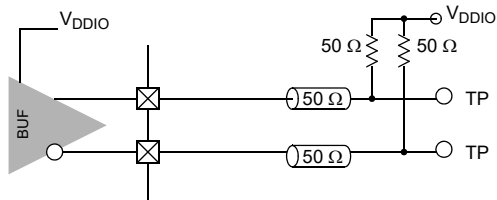
**Figure 21. LVPECL Output Load and Test Circuit**



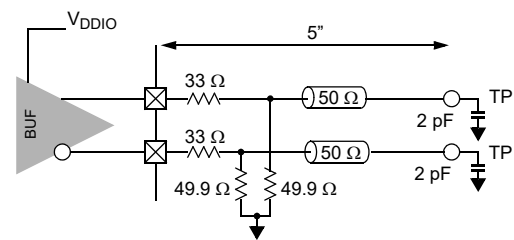
**Figure 22. LVDS Output Load and Test Circuit**



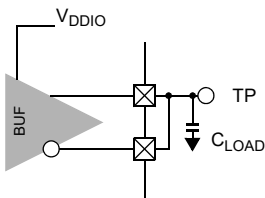
**Figure 23. CML Output Load and Test Circuit**



**Figure 24. HCSL Output Load and Test Circuit**

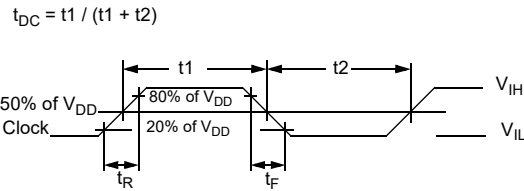


**Figure 25. LVCMOS Output Load and Test Circuit**

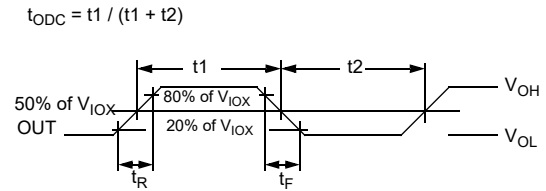


## Voltage and Timing Definitions

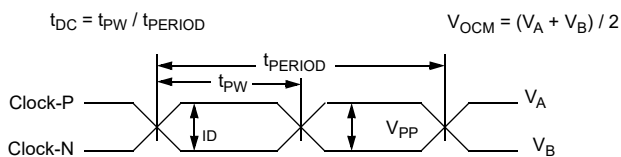
**Figure 26. LVCMOS Input Definitions**



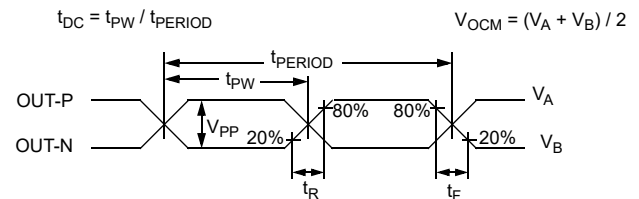
**Figure 27. LVCMOS Output Definitions**



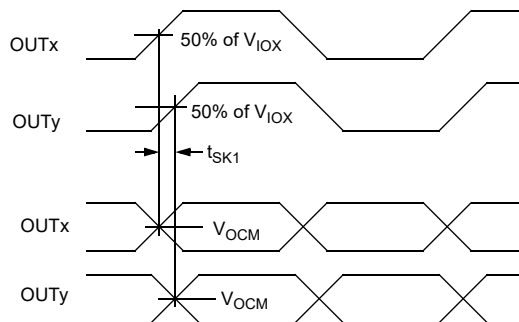
**Figure 28. Differential Input Definitions**



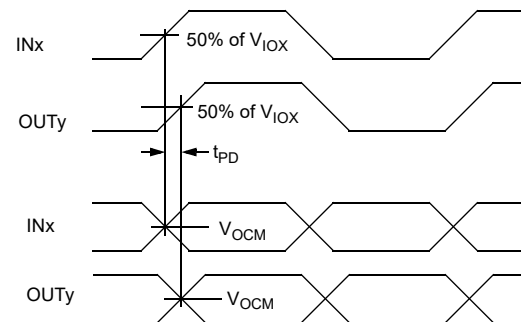
**Figure 29. Differential Output Definitions**



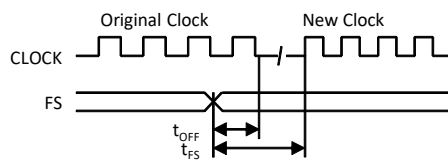
**Figure 30. Skew Definition**



**Figure 31. Propagation Delay Definition**

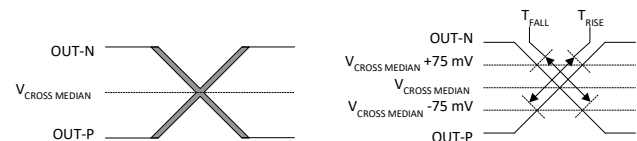


**Figure 32. Output Enable/Disable/Frequency Select Timing**



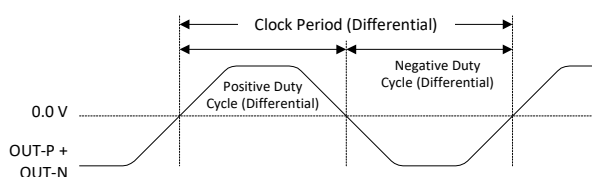
**Figure 33. HCSL Single-ended Measurement Point-2**

Rise and Fall Time Matching

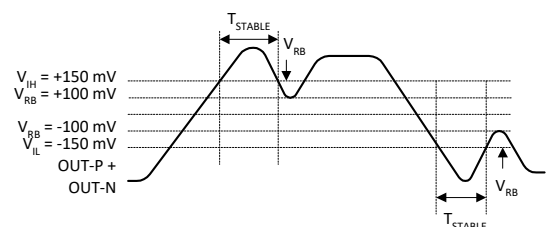


**Figure 34. HCSL Differential Measurement Point**

Duty Cycle and Period

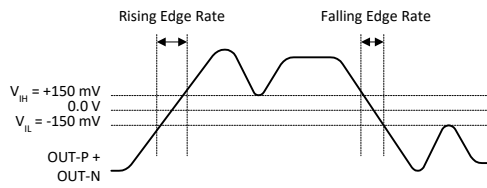
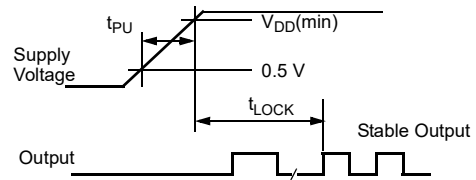
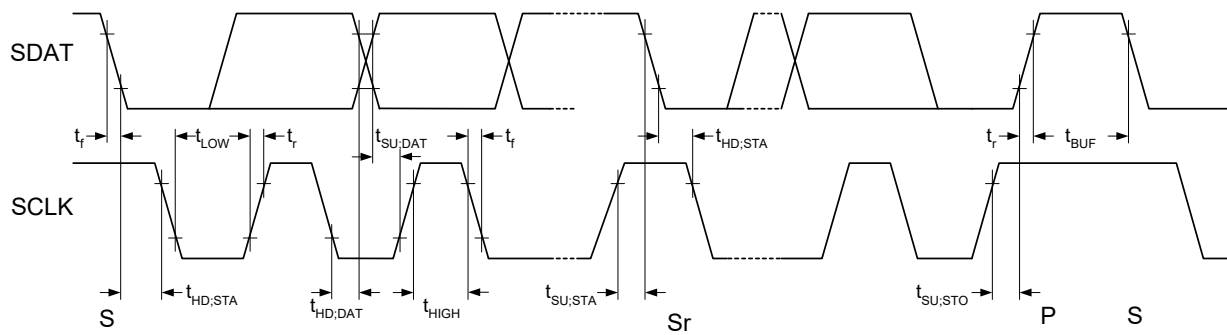


**Figure 35. HCSL Differential Measurement for Ringback**



**Figure 36. HCSL Rise and Fall Time**

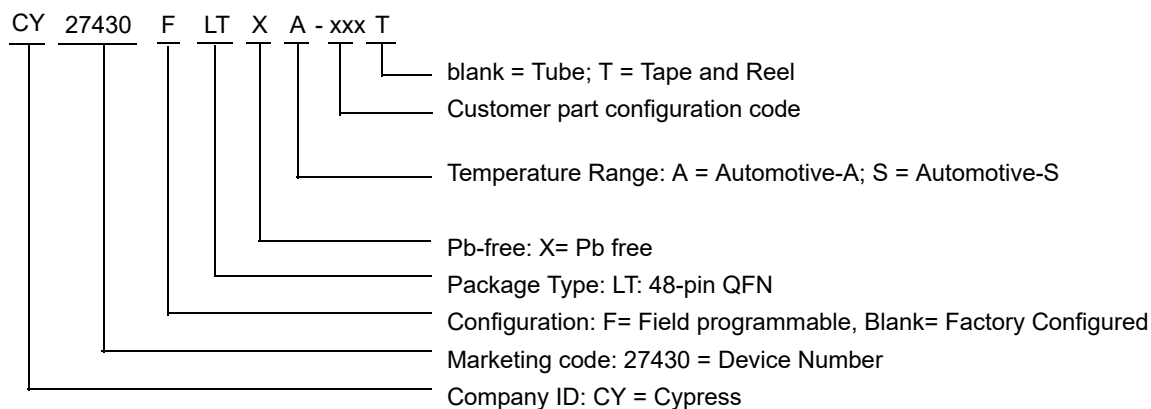
Rise and Fall Time


**Figure 37. Power Ramp and PLL Lock Time**

**Figure 38. Definition for Timing for Fast/Standard Mode on the I<sup>2</sup>C Bus**




The following table lists the CY27430 device's key package features and ordering codes.

| Part Number       | Configuration      | Package                    | Type         |
|-------------------|--------------------|----------------------------|--------------|
| CY27430FLTxA      | Field Programmable | 48-pin QFN                 | Automotive-A |
| CY27430FLTxA-T    | Field Programmable | 48-pin QFN – Tape and Reel | Automotive-A |
| CY27430FLTXS      | Field Programmable | 48-pin QFN                 | Automotive-S |
| CY27430FLTXS-T    | Field Programmable | 48-pin QFN – Tape and Reel | Automotive-S |
| CY27430LTxA-xxx   | Factory configured | 48-pin QFN                 | Automotive-A |
| CY27430LTxA-xxx-T | Factory configured | 48-pin QFN – Tape and Reel | Automotive-A |
| CY27430LTXS-xxx   | Factory configured | 48-pin QFN                 | Automotive-S |
| CY27430LTXS-xxx-T | Factory configured | 48-pin QFN – Tape and Reel | Automotive-S |

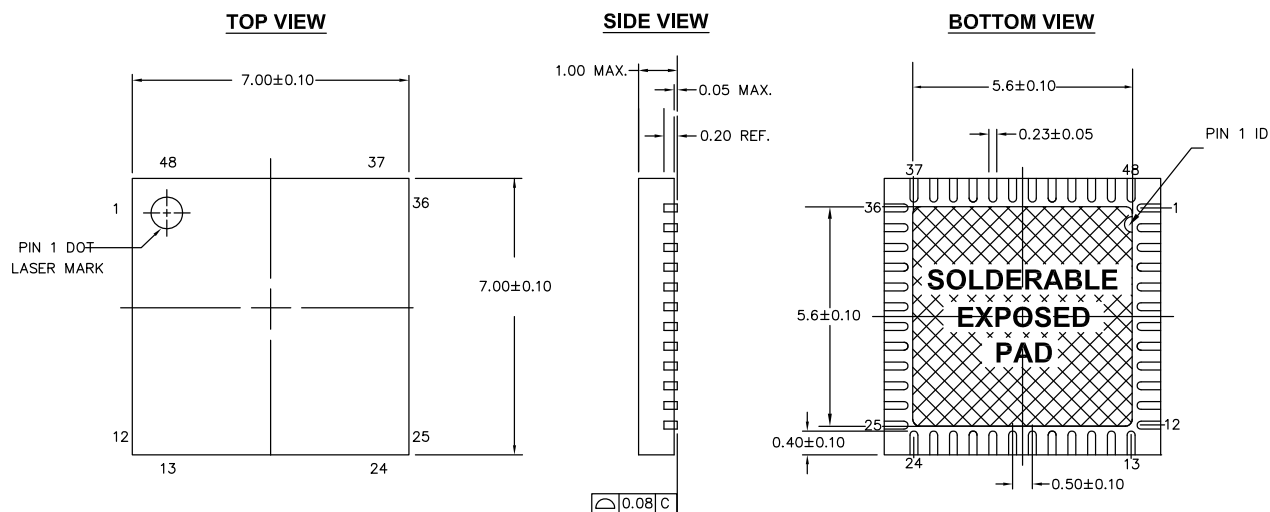


## Packaging Information

This section illustrates the packaging specifications for the CY27430 device, along with the thermal impedances for each package.

**Important Note** The EPAD must be connected to ground to reduce the thermal resistance and for signaling ground.

**Figure 39. 48-pin QFN (7 × 7 × 1.00 mm) LT48D 5.5 x 5.5 EPAD (Sawn Type) Package Outline, 001-45616**



### NOTES:

1.  HATCH AREA IS SOLDERABLE EXPOSED METAL.
2. REFERENCE JEDEC#: MO-220
3. PACKAGE WEIGHT: REFER TO PMDD SPEC.
4. ALL DIMENSIONS ARE IN MM [MIN/MAX]
5. PACKAGE CODE

| PART # | DESCRIPTION |
|--------|-------------|
| LT48D  | LEAD FREE   |

001-45616 \*F

For information on the preferred dimensions for mounting QFN packages, refer to the Cypress [application note AN72845 - Design Guidelines for Cypress Quad Flat No Extended Lead \(QFN\) Packaged Devices](#).

## Solder Reflow Specifications

Table 24 shows the solder reflow temperature limits that must not be exceeded.

**Table 24. Solder Reflow Specifications**

| Package    | Maximum Peak Temperature (T <sub>C</sub> ) | Maximum Time above T <sub>C</sub> – 5 °C |
|------------|--------------------------------------------|------------------------------------------|
| 48-pin QFN | 260 °C                                     | 30 seconds                               |

## Acronyms

**Table 25. Acronyms Used in this Document**

| Acronym          | Description                                         |
|------------------|-----------------------------------------------------|
| AC               | alternating current                                 |
| ADC              | analog-to-digital converter                         |
| API              | application programming interface                   |
| CML              | current-mode logic                                  |
| CMOS             | complementary metal oxide semiconductor             |
| DC               | direct current                                      |
| ESD              | electrostatic discharge                             |
| FS               | frequency select                                    |
| GUI              | graphical user interface                            |
| HCSL             | high-speed current steering logic                   |
| I <sup>2</sup> C | inter-integrated circuit                            |
| I/O              | input/output                                        |
| ISSP             | in-system serial programming                        |
| JEDEC            | Joint Electron Devices Engineering Council          |
| LDO              | low dropout (regulator)                             |
| LSB              | least-significant bit                               |
| LVC MOS          | low voltage complementary metal oxide semiconductor |
| LVDS             | low-voltage differential signals                    |
| LVPECL           | low-voltage positive emitter-coupled logic          |
| MSB              | most-significant byte                               |
| NV               | non-volatile                                        |
| NZDB             | non-zero delay buffer                               |
| OE               | output enable                                       |
| PCIe             | PCI express                                         |
| POR              | power-on reset                                      |
| PSoC®            | Programmable System-on-Chip                         |
| QFN              | quad flat no-lead                                   |
| RMS              | root mean square                                    |
| SCLK             | serial I <sup>2</sup> C clock                       |
| SDAT             | serial I <sup>2</sup> C data                        |
| TSSOP            | thin shrunk small outline package                   |
| USB              | universal serial bus                                |
| XTAL             | crystal                                             |
| ZDB              | zero delay buffer                                   |

## Document Conventions

### Units of Measure

**Table 26. Units of Measure**

| Symbol | Unit of Measure                  |
|--------|----------------------------------|
| °C     | degree Celsius                   |
| dBc    | decibels relative to the carrier |
| fF     | femtofarad                       |
| fs     | femtosecond                      |
| g      | gram                             |
| GHz    | gigahertz                        |
| Hz     | hertz                            |
| KHz    | kilohertz                        |
| Ksps   | kilo samples per second          |
| kΩ     | kilohm                           |
| MHz    | megahertz                        |
| MΩ     | megaohm                          |
| μA     | microampere                      |
| μF     | microfarad                       |
| μH     | microhenry                       |
| μs     | microsecond                      |
| μW     | microwatt                        |
| mA     | milliampere                      |
| ms     | millisecond                      |
| mV     | millivolt                        |
| nA     | nanoampere                       |
| nF     | nanofarad                        |
| ns     | nanosecond                       |
| nV     | nanovolt                         |
| Ω      | ohm                              |
| pA     | picoampere                       |
| pF     | picofarad                        |
| pp     | peak-to-peak                     |
| ppm    | parts per million                |
| ppb    | parts per billion                |
| ps     | picosecond                       |
| sps    | samples per second               |
| σ      | sigma: one standard deviation    |
| V      | volt                             |
| W      | watt                             |

## Document History Page

| Document Title: CY27430, Four-PLL Spread-Spectrum Clock Generator<br>Document Number: 001-99376 |         |                 |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-------------------------------------------------------------------------------------------------|---------|-----------------|-----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rev.                                                                                            | ECN     | Orig. of Change | Submission Date | Description of Change                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| **                                                                                              | 4889846 | XHT             | 10/29/2015      | New data sheet.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| *A                                                                                              | 5351208 | XHT             | 07/14/2016      | Updated to new template.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| *B                                                                                              | 5547117 | XHT             | 12/08/2016      | Added Automotive-S temperature range related information in all instances across the document.<br>Updated <a href="#">Ordering Information</a> :<br>Updated part numbers.<br>Updated <a href="#">Packaging Information</a> :<br>spec 001-45616 – Changed revision from *E to *F.<br>Updated to new template.                                                                                                                                                                                                                                                |
| *C                                                                                              | 5942666 | XHT             | 10/26/2017      | Removed Preliminary.<br>Updated the text “four registers” to “eight registers” in <a href="#">Functional Description</a> .<br>Removed “IN2 input buffer off” for I <sub>DDXO</sub> parameter in <a href="#">Table 6</a> .<br>Removed “IN2” for C <sub>IN</sub> parameter in <a href="#">Table 7</a> .<br>Changed IDDO(max) parameters for HCSL, LVDS, LVPECL (VDD-1.7V) and IDDP <sub>LL1</sub> .<br>Changed LVDS VOCM parameters.<br>Added Theta-JC parameter.<br>Added factory configured part number.<br>Removed ES identifier.<br>Updated the template. |

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